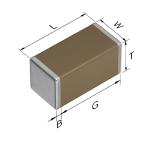
积层贴片陶瓷片式电容器

C3216X7T2J333K115AC

RoHS Reach Halogen Free Pb Free

交货型号	C3216X7T2J333KT****	
用途	一般等级 车载用途时为 <u>CGA5H1X7T2J333K115AC</u> 。	
特点	Mid 中耐压 (100∼630V)	
系列	C3216 [EIA 1206]	
状态	▲ 量产体制(新设计非推荐)	



)	₹┪
长度(L)	3. 20mm ±0. 20mm
宽度(W)	1.60mm ±0.20mm
厚度(T)	1.15mm ± 0.15 mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	1.00mm Min.
推荐焊盘布局(PA)	2.10mm to 2.50mm(Flow Soldering)
推存烃益和向(PA)	2.00mm to 2.40mm(Reflow Soldering)
推荐焊盘布局(PB)	1.10mm to 1.30mm(Flow Soldering)
]E行外血加加 (t D)	1.00mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PC)	1.00mm to 1.30mm(Flow Soldering)
3世行が加工作/四 は U/	1.10mm to 1.60mm(Reflow Soldering)

电气特性		
电容	$33nF \pm 10\%$	
额定电压	630VDC	
温度特性	X7T (+22, -33%)	
耗散因数(Max.)	2. 5%	
绝缘电阻 (Min.)	10000M Ω	

	其他
焊接方法	流体
汗 致刀化	回流
AEC-Q200	NO
包装形式	塑封编带 (180mm卷筒)
包装个数	2000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

 $^{! \ \}mbox{All specifications}$ are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

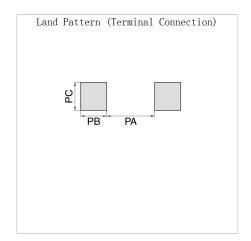
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Associated Images



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